

# LEXAN™ COPOLYMER EXL1182T

REGION EUROPE

## DESCRIPTION

LEXAN EXL1182T polycarbonate (PC) siloxane copolymer resin is a UV stabilized, enhanced release transparent injection molding (IM) grade. This resin offers good low temperature (-20 C) ductility in combination with high flow characteristics and excellent processability with opportunities for shorter IM cycle times compared to standard PC resins. LEXAN EXL1182T resin is a UV stabilized, enhanced release product available in transparent and opaque colors and may be an excellent candidate for a broad range of applications.

## TYPICAL PROPERTY VALUES

Revision 20180905

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
<b>MECHANICAL</b>			
Tensile Stress, yld, Type I, 50 mm/min	58	MPa	ASTM D 638
Tensile Stress, brk, Type I, 50 mm/min	57	MPa	ASTM D 638
Tensile Strain, yld, Type I, 50 mm/min	5.7	%	ASTM D 638
Tensile Strain, brk, Type I, 50 mm/min	117.9	%	ASTM D 638
Tensile Modulus, 50 mm/min	2260	MPa	ASTM D 638
Flexural Stress, yld, 1.3 mm/min, 50 mm span	94	MPa	ASTM D 790
Flexural Modulus, 1.3 mm/min, 50 mm span	2240	MPa	ASTM D 790
Tensile Stress, yield, 50 mm/min	57	MPa	ISO 527
Tensile Stress, break, 50 mm/min	56	MPa	ISO 527
Tensile Strain, yield, 50 mm/min	5.4	%	ISO 527
Tensile Strain, break, 50 mm/min	119.4	%	ISO 527
Tensile Modulus, 1 mm/min	2340	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	89	MPa	ISO 178
Flexural Modulus, 2 mm/min	2140	MPa	ISO 178
<b>IMPACT</b>			
Izod Impact, notched, 23°C	736	J/m	ASTM D 256
Izod Impact, notched, -30°C	618	J/m	ASTM D 256
Instrumented Impact Total Energy, 23°C	74	J	ASTM D 3763
Izod Impact, notched 80*10*4 +23°C	47	kJ/m <sup>2</sup>	ISO 180/1A
Izod Impact, notched 80*10*4 -30°C	24	kJ/m <sup>2</sup>	ISO 180/1A
Charpy 23°C, V-notch Edgew 80*10*4 sp=62mm	61	kJ/m <sup>2</sup>	ISO 179/1eA
Charpy -30°C, V-notch Edgew 80*10*4 sp=62mm	17	kJ/m <sup>2</sup>	ISO 179/1eA
<b>THERMAL</b>			
Vicat Softening Temp, Rate A/50	138	°C	ASTM D 1525
HDT, 1.82 MPa, 3.2mm, unannealed	121	°C	ASTM D 648
CTE, -40°C to 95°C, flow	7.48E-05	1/°C	ASTM E 831
CTE, -40°C to 95°C, xflow	7.64E-05	1/°C	ASTM E 831
CTE, 23°C to 80°C, flow	7.48E-05	1/°C	ISO 11359-2
CTE, 23°C to 80°C, xflow	7.64E-05	1/°C	ISO 11359-2
Vicat Softening Temp, Rate B/50	138	°C	ISO 306
Vicat Softening Temp, Rate B/120	139	°C	ISO 306
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	116	°C	ISO 75/Af
<b>PHYSICAL</b>			

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Specific Gravity	1.19	-	ASTM D 792
Mold Shrinkage, flow, 3.2 mm	0.4 – 0.8	%	SABIC method
Melt Flow Rate, 300°C/1.2 kgf	20	g/10 min	ASTM D 1238
Density	1.19	g/cm <sup>3</sup>	ISO 1183
Water Absorption, (23°C/sat)	0.24	%	ISO 62
Moisture Absorption (23°C / 50% RH)	0.09	%	ISO 62
Melt Volume Rate, MVR at 300°C/1.2 kg	19	cm <sup>3</sup> /10 min	ISO 1133
<b>INJECTION MOLDING</b>			
Drying Temperature	120	°C	
Drying Time	3 – 4	hrs	
Drying Time (Cumulative)	48	hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	295 – 315	°C	
Nozzle Temperature	290 – 310	°C	
Front - Zone 3 Temperature	295 – 315	°C	
Middle - Zone 2 Temperature	280 – 305	°C	
Rear - Zone 1 Temperature	270 – 295	°C	
Mold Temperature	70 – 95	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw Speed	40 – 70	rpm	
Shot to Cylinder Size	40 – 60	%	
Vent Depth	0.025 – 0.076	mm	

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